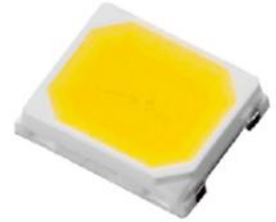


2835B03-XXH02-2P-D231-LX Datasheet

This 2835 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light and etc.

此款2835 LED光源是一款节能器件，具有良好的散热性、可以承受大电流使用。产品外形小巧，强度高，是LED面板灯、LED球泡灯、LED管灯等产品的理想选择。



The White Power LED is available in the range of color temperature from 2600K to 7000K.

色温范围涵盖2600K至7000K。

This part has a foot print that is compatible to most of the same size LED in the market today.

此款LED光源焊盘结构与市场上主流LED光源焊盘尺寸基本相同。

FEATURES/特点

- Available in Cool White, Neutral White and Warm White color
颜色包括冷白、中性白和暖白
- ANSI-compatible chromaticity bins
符合美标ANSI色坐标分BIN标准
- High luminous Intensity and high efficiency
高亮度、高光效
- Compatible with reflow soldering process
匹配回流焊制程
- Low thermal resistance/低热阻
- Long operation life/长寿命
- Wide viewing angle at 120°
发光角度 120°
- Silicone encapsulation/硅胶封装
- Environmental friendly, RoHS compliance
环保材质，符合RoHS要求

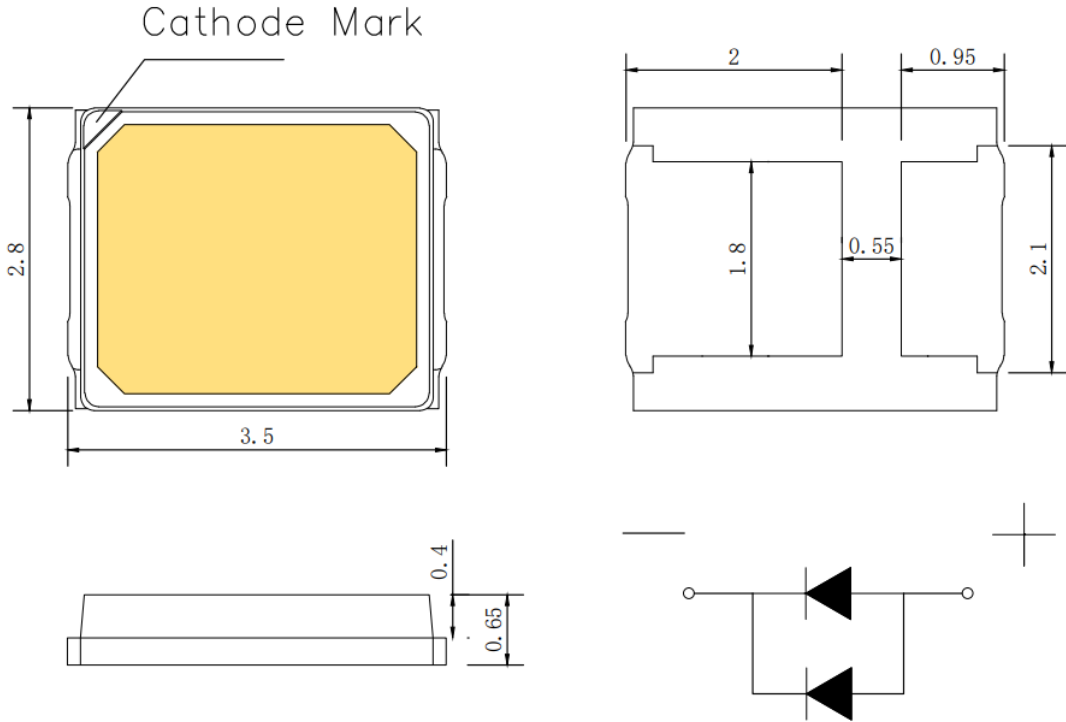
APPLICATIONS/应用

- Flat panel light/面板灯
- LED tube light/LED管灯
- LED bulb light/LED球泡灯
- Decorative and landscape lighting
装饰和景观照明
- Signage and channel letter
标识和发光字牌
- Reading lamp/台灯
- Decorating and entertainment lighting
装修和娱乐照明
- Architectural lighting
建筑照明

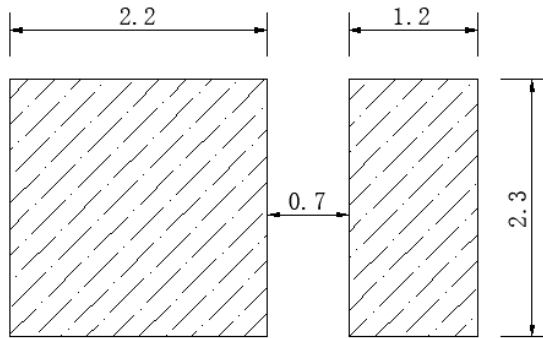
Note: The information in this document is subject to change without notice.

注:本文件内的资料如有更改，恕不另行通知。

PACKAGE DIMENSIONS 封装尺寸



Recommended Solder Pad Design 推荐焊盘设计



Notes/ 注:

1. All dimensions in millimeters. 所有尺寸单位为mm
2. Thickness tolerance of copper plate is ± 0.02 mm. 铜材料片厚度公差为 ± 0.02 mm
3. Thickness tolerance of product is ± 0.05 mm. 产品厚度公差为 ± 0.05 mm
4. Tolerance is ± 0.1 mm unless otherwise noted. 如未特别注明, 默认公差为 ± 0.1 mm

ABSOLUTE MAXIMUM RATINGS 最大限定参数 (Ta=25°C)

Parameter 项目名称	Symbol 符号	Value 规格	Unit 单位
Forward current 正向电流	IF	300	mA
Peak Forward Current 正向脉冲电流	IFP	450	mA
Power Dissipation 消耗功率	Pd	1000	mW
Operating Temperature 工作温度	Topr	-40~+85	°C
Storage Temperature 储存温度	Tstg	-40~+100	°C
Soldering Temperature 焊接温度	Tsld	Reflow Soldering: 260°C for 10 seconds	
LED Junction Temperature 结温	Tj	125	°C

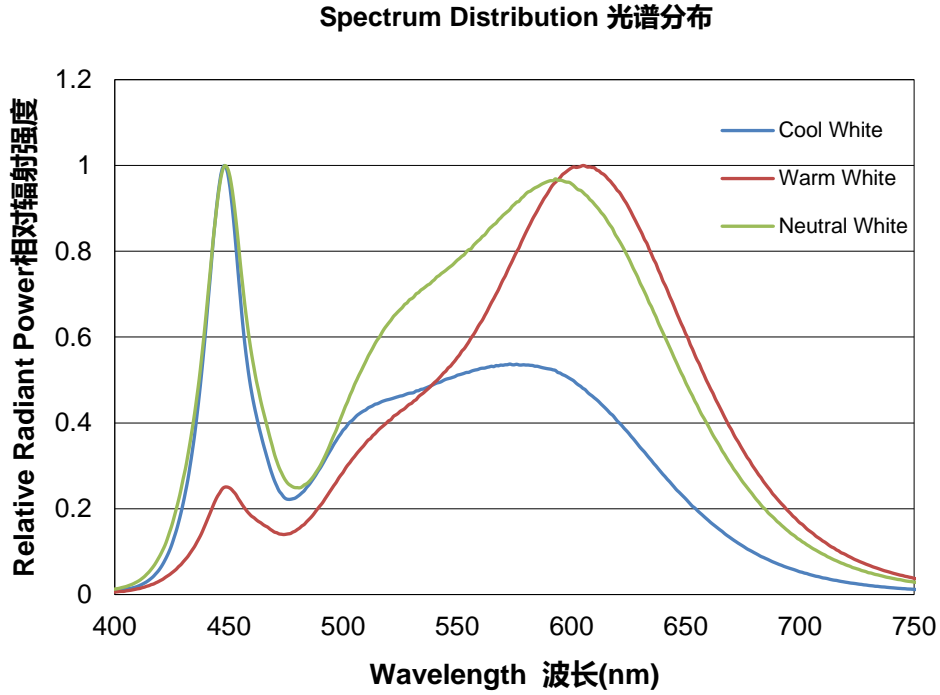
ELECTRO-OPTICAL CHARACTERISTICS 主要光电参数(Ta=25°C)

Parameter 项目名称	Symbol 符号	Test Condition 测试条件	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Forward Voltage 正向电压	V_F	IF=65mA	2.6		2.8	V
Viewing Angle 发光角度	$2\theta_{1/2}$	IF=65mA	--	120	--	deg.
Luminous Flux 光通量	Φ_v	IF=65mA	34	--	40	lm
Color Rendering Index 显色指数	CRI	IF=65mA	80	--	--	--
Color Temperature 色温	CCT	IF=65mA	2600	--	7000	K
Thermal Resistance 热阻	R_{th-js}	IF=65mA	--	10	--	°C/W

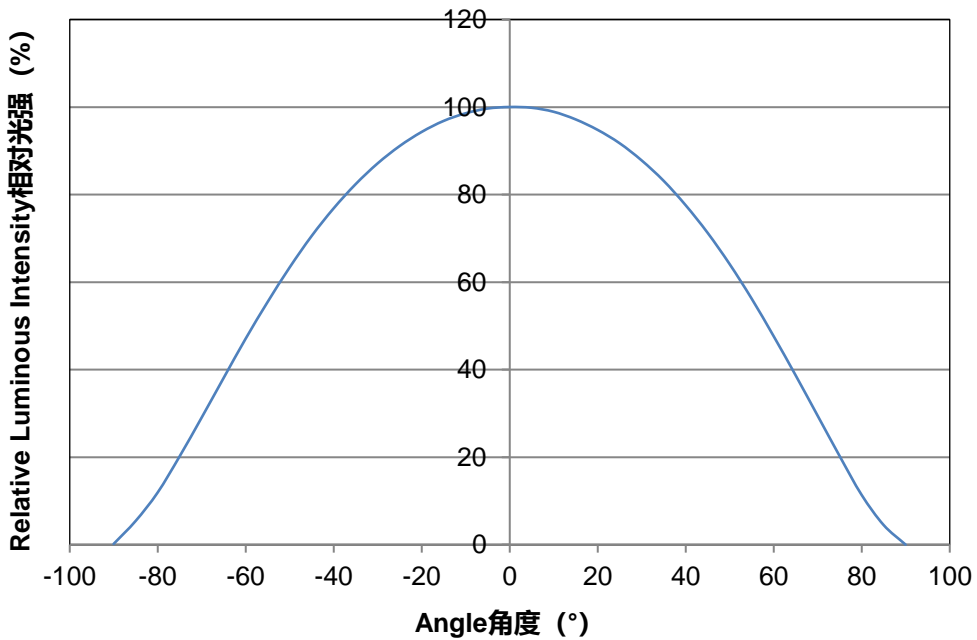
Notes 注:

- Luminous flux is measured with an accuracy of $\pm 5\%$. 光通量的测量精度为 $\pm 5\%$ 。
- Chromaticity coordinate bins are measured with an accuracy of ± 0.01 . 色度坐标相对测量精度为 ± 0.01
- CRI is measured with an accuracy of ± 2 . 显色指数测量精度为 ± 2
- Some color and CRI bins may have limited availability, please contact us before ordering.
部分颜色和显指可能有限制, 请在订购前与我们联系
- All measurements were made under the standardized environment of Shineon
所有的测量都是在易美的标准环境下进行的

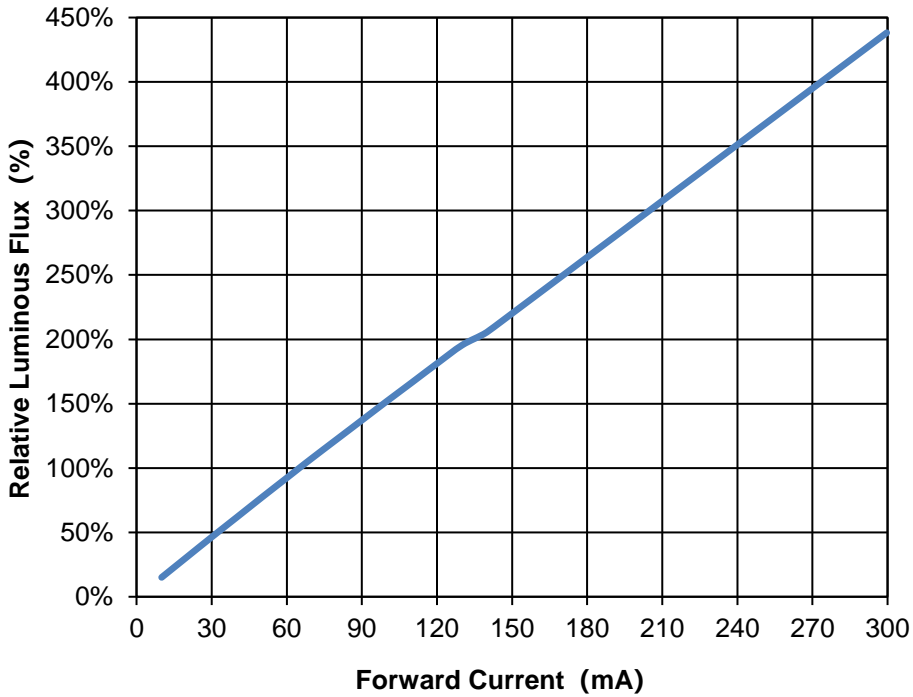
RELATIVE SPECTRAL POWER DISTRIBUTION 相对光谱功率分布 (T_j=25°C)



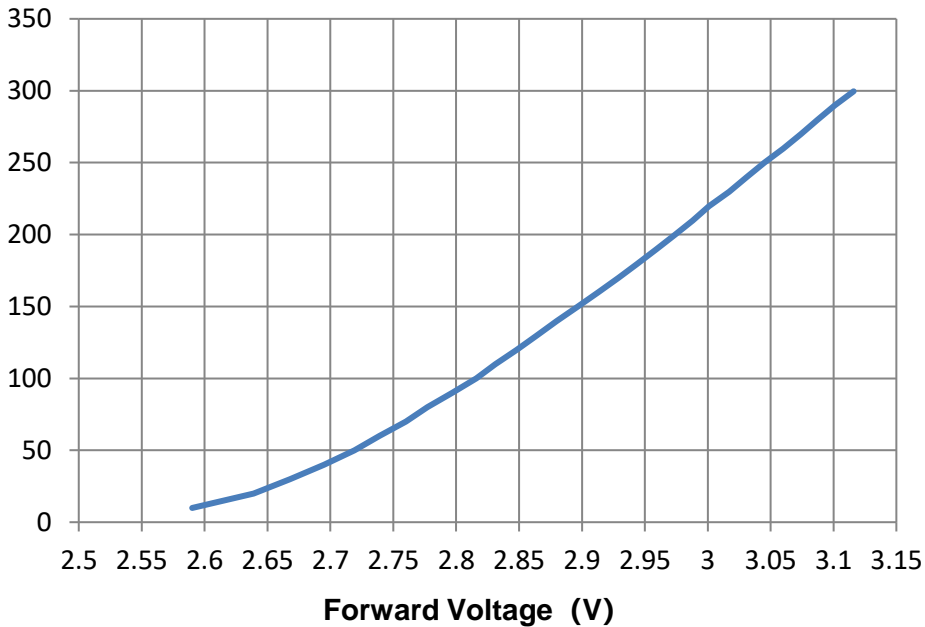
TYPICAL SPATIAL DISTRIBUTION 典型配光分布



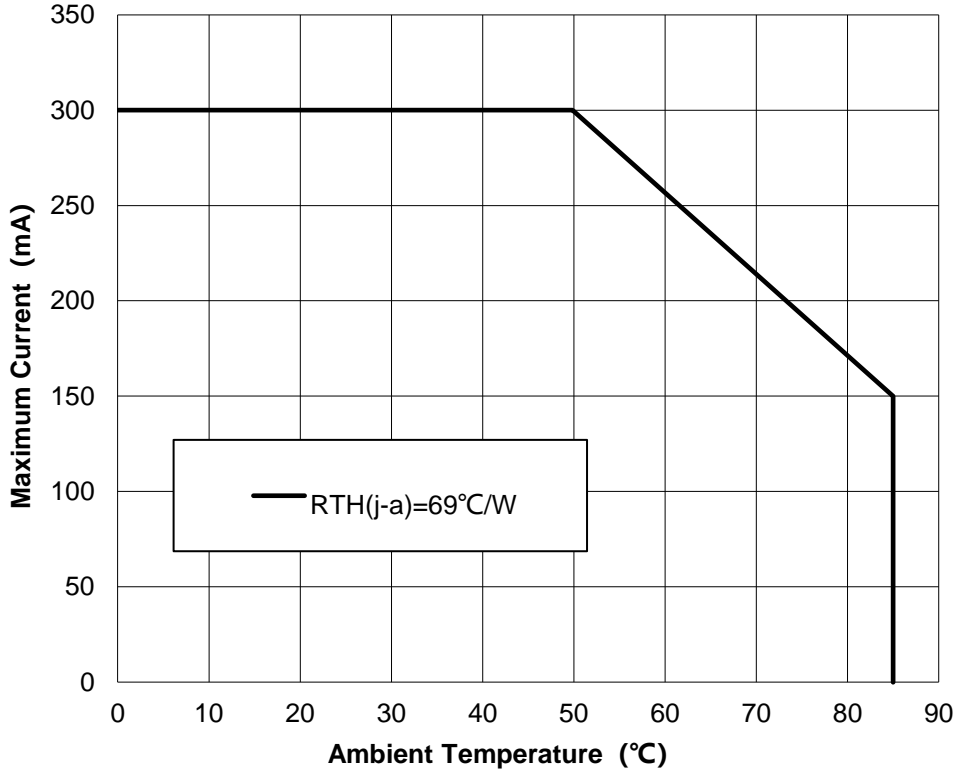
RELATIVE LUMINOUS FLUX VS. CURRENT 相对光通量VS电流 ($T_j=25^\circ\text{C}$)



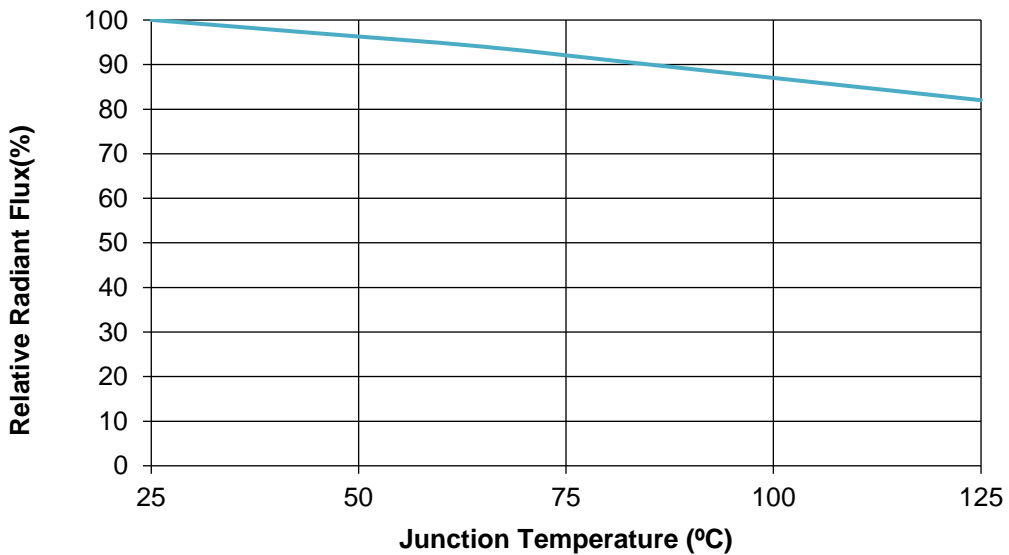
ELECTRICAL CHARACTERISTICS 电特性 ($T_j=25^\circ\text{C}$)



MAXIMUM CURRENT VS. AMBIENT TEMPERATURE 最大电流VS环境温度



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE 相对辐射通量VS结温



SORTING RANKS 分光等级
(1) Luminous Flux 光通量 (Tj=25°C)

Part Number 品名	Condition 条件	Rank 等级	Unit 单位
2835B03-27H02-2P-D231-LX	65mA	Q2	lm
		34-36	
2835B03-30H02-2P-D231-LX		O3	
		36-38	
2835B03-40H02-2P-D231-LX		O4	
		38-40	
2835B03-50H02-2P-D231-LX		O4	
		38-40	
2835B03-57H02-2P-D231-LX		O4	
		38-40	
2835B03-60H02-2P-D231-LX	O33		
	37-39		
2835B03-65H02-2P-D231-LX	O33		
	37-39		

(2) Forward Voltage 正向电压(Tj=25°C)

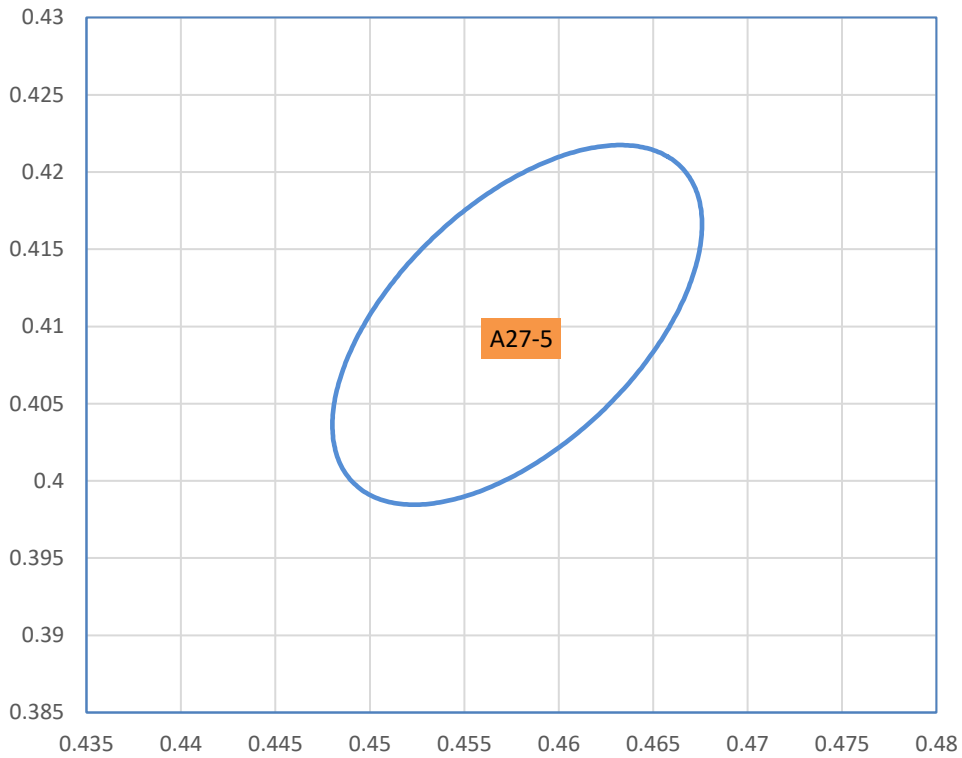
Rank 等级	Condition 条件	Min. 最小值	Max. 最大值	Unit 单位
A6	65mA	2.6	2.7	V
A7		2.7	2.8	

Notes 注：

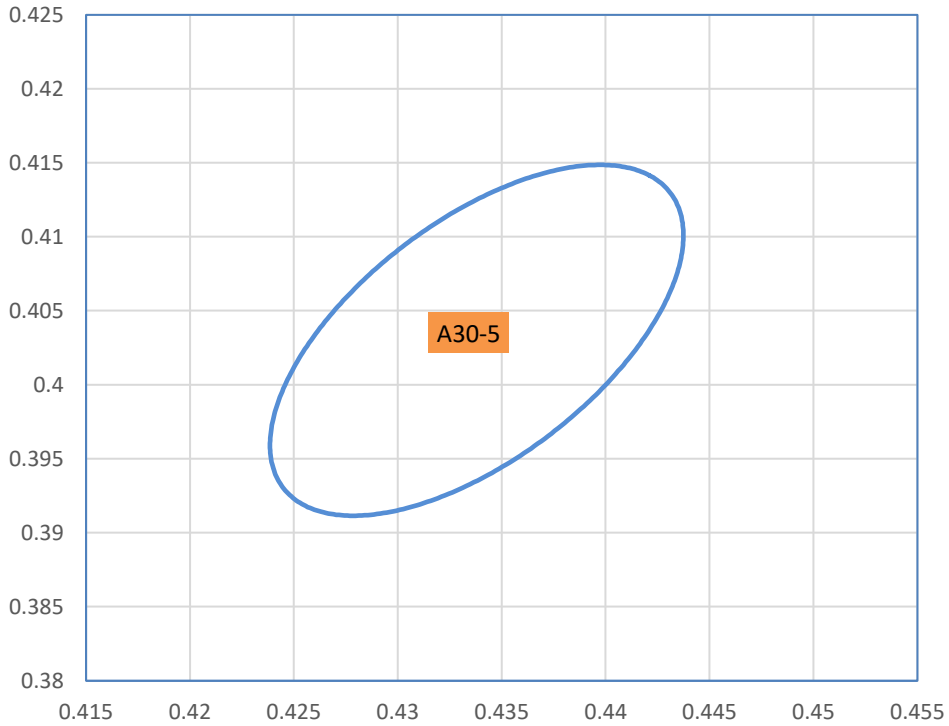
- 5% tolerance for luminous intensity may be caused by measurement inaccuracy.
光通量测量精度误差± 5%
- Measurement Uncertainty of the Forward Voltage : ± 0.05V
正向电压测量误差:± 0.05V

(3) Chromaticity Bins 色坐标等级

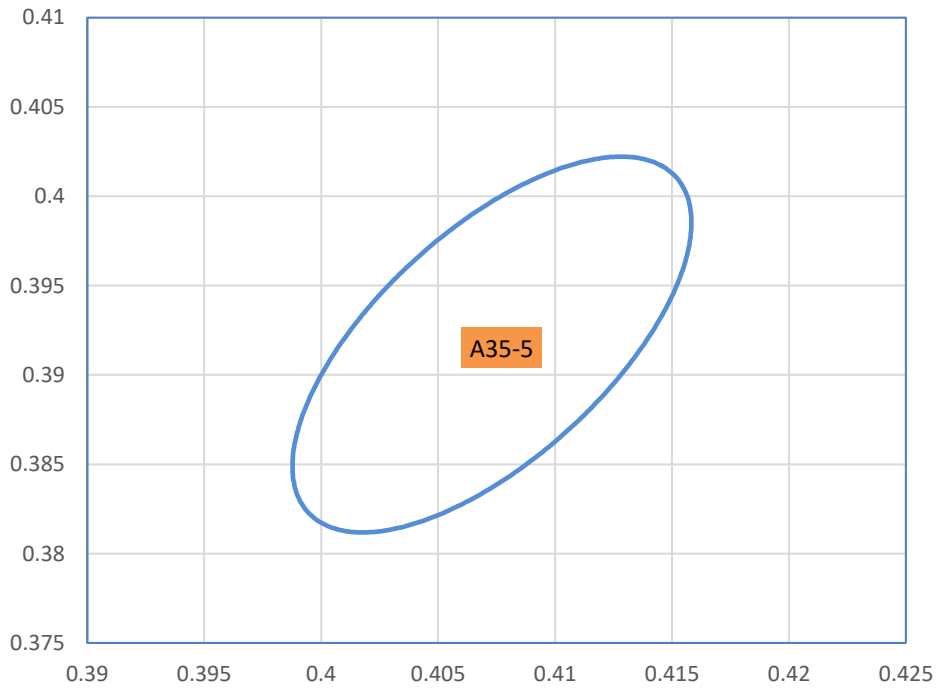
Part Number 品名	2835B03-27H02-2P-D231-LX			CCT 色温	2700K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A27-5	x	y	a	b	Theta°
	0.4578	0.4101	0.01290	0.00685	53.17



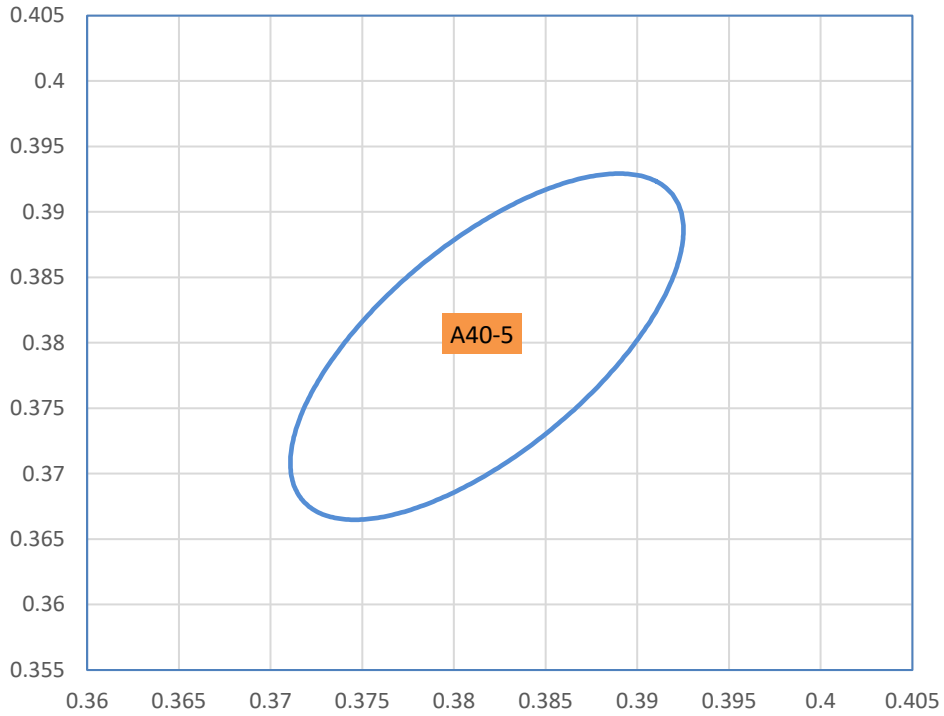
Part Number 品名	2835B03-30H02-2P-D231-LX			CCT 色温	3000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A30-5	x	y	a	b	Theta°
	0.4338	0.403	0.01390	0.00680	53.2167



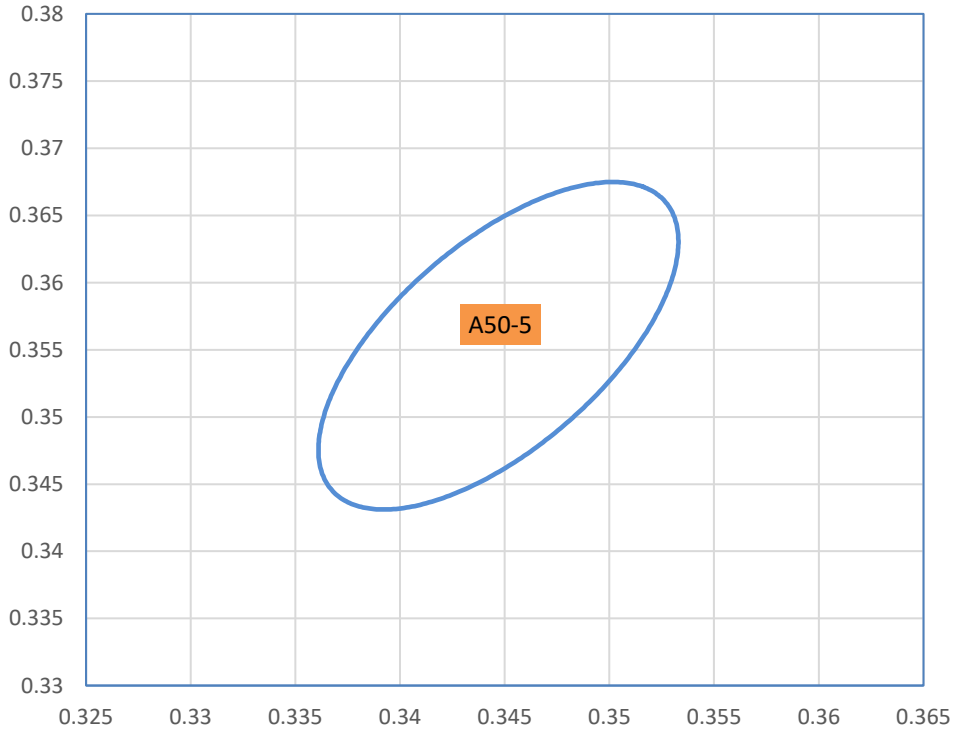
Part Number 品名	2835B03-35H02-2P-D231-LX			CCT 色温	3500K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A35-5	x	y	a	b	Theta°
	0.4073	0.3917	0.01545	0.0069	54



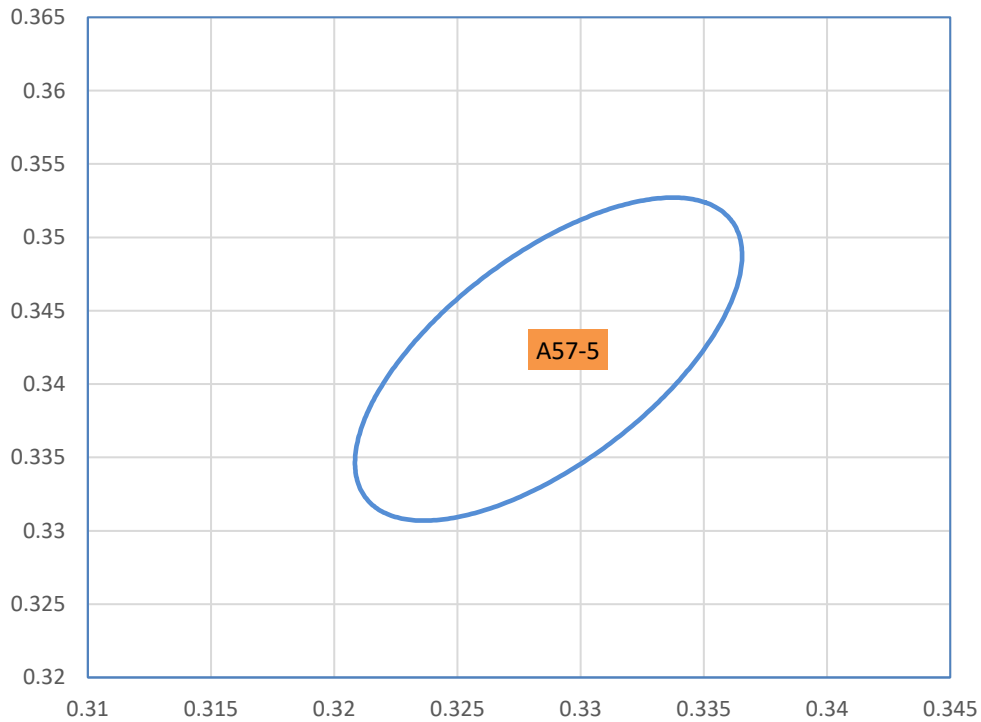
Part Number 品名	2835B03-40H02-2P-D231-LX			CCT 色温	4000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A40-5	x	y	a	b	Theta°
	0.3818	0.3797	0.01565	0.00670	53.717



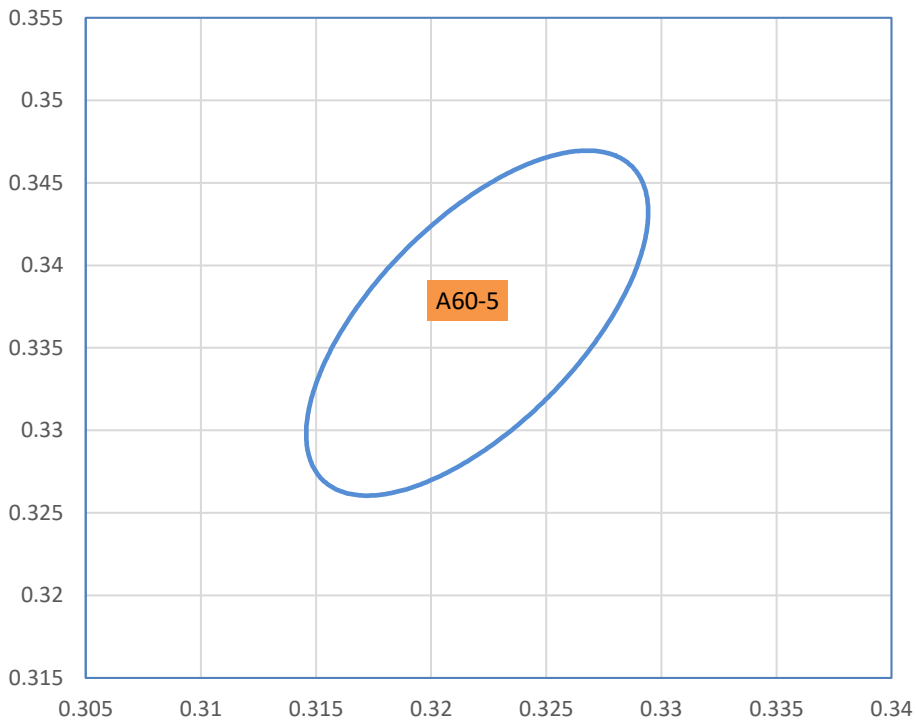
Part Number 品名	2835B03-50H02-2P-D231-LX			CCT 色温	5000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A50-5	x	y	a	b	Theta°
	0.3447	0.3553	0.01370	0.00590	59.617



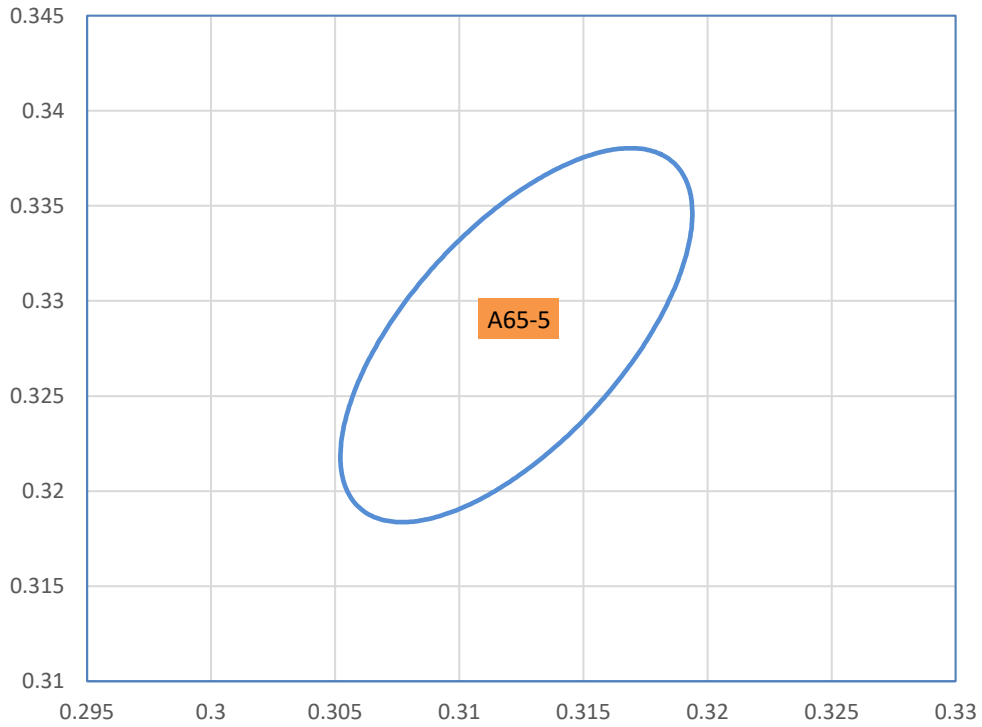
Part Number 品名	2835B03-57H02-2P-D231-LX			CCT 色温	5700K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A57-5	x	y	a	b	Theta°
	0.3287	0.3417	0.01245	0.00535	59.128



Part Number 品名	2835B03-60H02-2P-D231-LX			CCT 色温	6000K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A60-5	x	y	a	b	Theta°
	0.322	0.3365	0.01179	0.00504	59.21



Part Number 品名	2835B03-65H02-2P-D231-LX			CCT 色温	6500K
Bin Code 等级代码	Color Coordinates 色坐标(x,y)				
A65-5	x	y	a	b	Theta°
	0.3123	0.3282	0.01115	0.00475	58.5667



REFLOW SOLDERING CHARACTERISTICS 回流焊特性

For Reflow Process 回流焊制程:

Preheating 预热 : 140°C~160°C±5°C, within 2 minutes. 2分钟

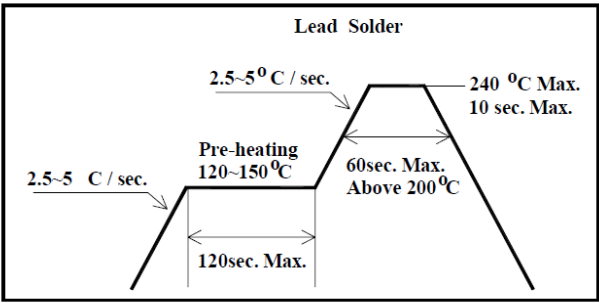
Operation heating 作业加热 : 260°C(Max.) within 10 seconds.(Max)

260°C(最高) within 10 seconds.(最长)

Gradual Cooling (Avoid quenching). 逐渐冷却(避免淬火)

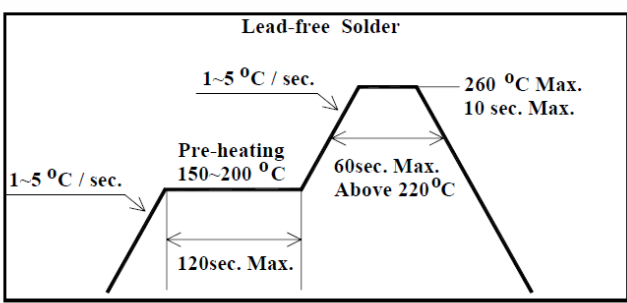
Lead solder 有铅焊接		Lead-free solder 无铅焊接	
Pre-heat 预热	120-150°C	Pre-heat 预热	150-200°C
Pre-heat time 预热时间	120 sec.Max.	Pre-heat time 预热时间	120 sec.Max.
Peak Temperature 峰值温度	240°C Max.	Peak Temperature 峰值温度	260°C Max.
Soldering condition 焊接条件	see below image 如下图	Soldering condition 焊接条件	see below image 如下图

Lead Solder



The diagram shows a reflow profile for lead solder. It starts with a heating rate of 2.5-5 °C/sec. The pre-heating phase is at 120-150 °C for a maximum of 120 seconds. The main reflow phase reaches a peak temperature of 240 °C Max. for a maximum of 10 seconds. The cooling rate is 2.5-5 °C/sec. A note indicates that the pre-heating time above 200 °C is a maximum of 60 seconds.

Lead-free Solder



The diagram shows a reflow profile for lead-free solder. It starts with a heating rate of 1-5 °C/sec. The pre-heating phase is at 150-200 °C for a maximum of 120 seconds. The main reflow phase reaches a peak temperature of 260 °C Max. for a maximum of 10 seconds. The cooling rate is 1-5 °C/sec. A note indicates that the pre-heating time above 220 °C is a maximum of 60 seconds.

Notes注:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

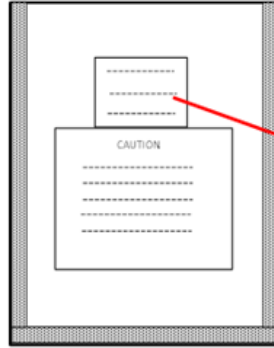
由于LED的封装材料是硅胶，led封装顶部表面是柔软的，顶部表面的压力会影响led的可靠性。应采取预防措施，以避免密封部件受到强大的压力。因此，在使用吸嘴时，应使硅胶表面的压力适中。

PACKAGING 包装



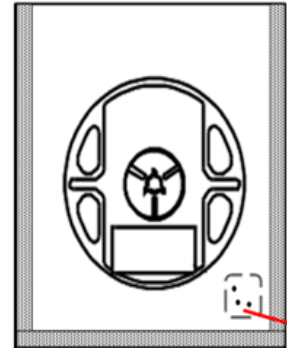
REEL
卷盘

Label



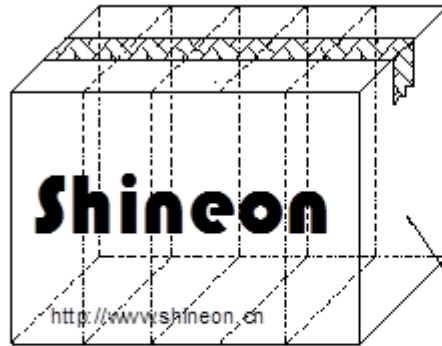
moisture-proof bag
防潮袋

Label



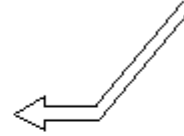
desiccant

干燥包



Outside box
Maximums 48 Reels

外箱
最多48卷盘



Reliability Test Items 可靠性测试项目

Test Items 测试项目	Test Duration 测试时长	Number of Damaged 不良数
Steady State Operating Life of High Temperature (HTOL) $T_s=85^{\circ}\text{C}$, $I_F=\text{Max}$ 高温点亮稳态老化 $T_s=85^{\circ}\text{C}$, $I_F=\text{最大值}$	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) $T_a=-40^{\circ}\text{C}$, $I_F=\text{Max}$ 低温点亮稳态老化 $T_s=85^{\circ}\text{C}$, $I_F=\text{最大值}$	1000hrs	0/20
High Temperature Storage (HTS) 高温存储 100°C	1000hrs	0/20
Low Temperature Storage (LTS) 低温存储 -40°C	1000hrs	0/20
Thermal Shock (TS) $-45^{\circ}\text{C}\sim 125^{\circ}\text{C}$ 15min dwell 30sec transfer 冷热冲击 -45°C 15min $\sim 125^{\circ}\text{C}$ 15min, 转换时间30秒	100cycles	0/20
Solder Resistance (SR) 265°C , 3X MSL 阻焊测试 (3遍潮气敏感度试验后)	5sec	0/20
Solder Ability (SA) 245°C 5sec, 95% coverage 可焊性 95%覆盖	5sec	0/11

Item 项目	Symbol 符号	Test Condition 测试条件	Criteria for Judgment 判定标准	
			Min. 最小	Max. 最大
Forward Voltage 正向电压	V_f	$I_F=\text{Typical Current}$ 典型电流		U.S.L x1.1
Luminous Flux 光通量	lm	$I_F=\text{Typical Current}$ 典型电流	L.S.L x0.7	
CCX&CCY X坐标&Y坐标	x,y	$I_F=\text{Typical Current}$ 典型电流		Shift<0.02 漂移<0.02

PRECAUTION FOR USE 使用注意事项

(1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.

本器件不得置于水、油、有机溶剂等任何流体中。如需清洁，请使用异丙醇进行清洗。

(2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

当LED发光工作时，应根据环境最高温度来确定工作电流。

(3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.

LED储存环境须保持清洁。如果LED从易美发货后需储存3个月或更长时间，则应使用氮气柜进行储存。

(4) The LEDs must be used within seven days after opening the moisture proof packing.

Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.

LED须在打开防潮包装后七天内使用。用防潮包装重新包装未使用的产品，折叠以封住开口，然后存放在干燥的地方。

(5) The appearance and specifications of the product may be modified for improvement without notice.

产品外观及规格如有改进，恕不另行通知。

(6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.

LED对静电和浪涌很敏感。在处理LED时，建议使用防静电腕带或防静电手套。

(7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase, turn-on voltage becomes lower and the LEDs get unlighted at low current.

手工焊接时，焊接仪器必须接地。如果对led施加超过绝对最大额定值的过电压，会对led造成损坏。损坏的led会出现一些不寻常的特性，如漏电流明显增加，接通电压降低，低电流时led不亮。